Vishay Siliconix

N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	30					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.00275					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.00340					
Q _g typ. (nC)	30					
I _D (A) ^a	39					
Configuration	Single					

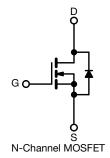
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: ´
 for definitions of compliance please see
 <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Low side DC/DC conversion
 - Notebook
 - Gaming



ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4126DY-T1-GE3			

PARAMETER Drain-source voltage Gate-source voltage		SYMBOL	LIMIT	UNIT
		V _{DS}	30	V
		V_{GS}	± 20	
	T _C = 25 °C		39	
Continuous drain current (T _J = 150 °C)	T _C = 70 °C		31	
	T _A = 25 °C	I _D	26.5 b, c	
	T _A = 70 °C		21 ^{b, c}	
Pulsed drain current		I _{DM}	70	A
Continuous source-drain diode current	T _C = 25 °C		7	
	T _A = 25 °C	l _S	3.1 ^{b, c}	
Single pulse avalanche current		I _{AS}	40	
Avalanche energy		E _{AS}	80	mJ
Maximum power dissipation	T _C = 25 °C		7.8	
	T _C = 70 °C		5	
	T _A = 25 °C	P _D	3.5 b, c	W
	T _A = 70 °C		2.2 b, c	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	29	35	°C/W		
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	13	16	7 °C/W		

Notes

- a. Based on TC = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 80 °C/W



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•				
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	24	-	mV/°C	
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	-	-6.4	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	-	2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
7	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	μА	
Zero gate voltage drain current		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Desire and a second sec	Б	V _{GS} = 10 V, I _D = 15 A	-	0.00220	0.00275	$-\Omega$	
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A	-	0.00270	0.00340		
Forward transconductance a	9 _{fs}	V _{GS} = 15 V, I _D = 15 A	-	75	-	S	
Dynamic ^b			•				
Input capacitance	C _{iss}		-	4405	-	pF	
Output capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	760	-		
Reverse transfer capacitance	C _{rss}		-	285	-		
Total gate charge	Qg	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 20 A	-	70	105		
			-	30	45		
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$	-	10.2	-	nC	
Gate-drain charge	Q_{gd}		-	7.4	-		
Gate resistance	R_g	f = 1 MHz	0.3	1.4	2.8	Ω	
Turn-on delay time	t _{d(on)}		-	36	60		
Rise time	t _r	$V_{DD} = 15 \text{ V, R}_{I} = 1.5 \Omega$	-	20	40		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	53	90		
Fall time	t _f		-	24	40		
Turn-on delay time	t _{d(on)}		-	15	30	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$	-	10	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	43	70		
Fall time	t _f		-	10	20		
Drain-Source Body Diode Characterist	ics			L	<u> </u>		
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	7		
Pulse diode forward current ^a	I _{SM}		-	-	70	Α	
Body diode voltage	V _{SD}	I _S = 3 A	-	0.71	1.1	V	
Body diode reverse recovery time	t _{rr}	-	-	38	60	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	38	60	nC	
Reverse recovery fall time	t _a	$T_{J} = 25 ^{\circ}\text{C}$	-	19	-		
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Notes

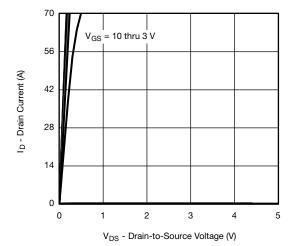
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

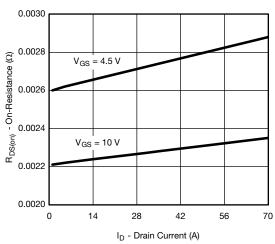
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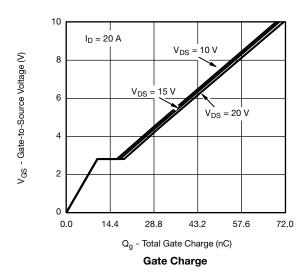
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

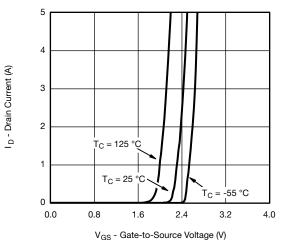


Output Characteristics

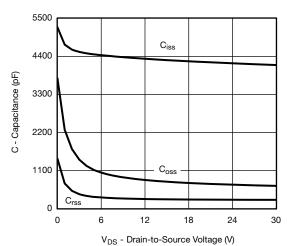


On-Resistance vs. Drain Current and Gate Voltage

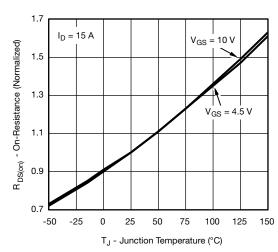




Transfer Characteristics



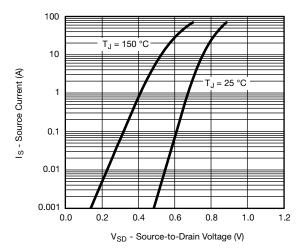
Capacitance



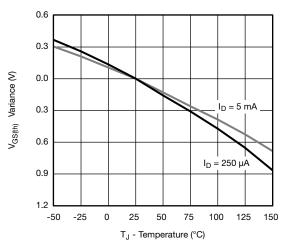
On-Resistance vs. Junction Temperature



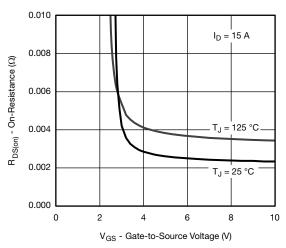
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



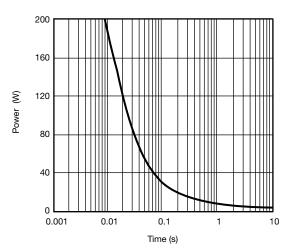
Source-Drain Diode Forward Voltage



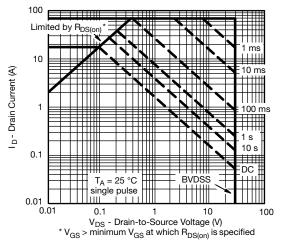
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



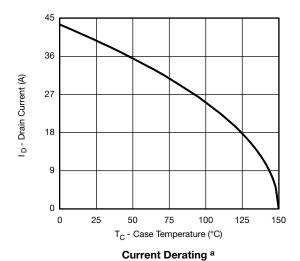
Single Pulse Power, Junction-to-Ambient

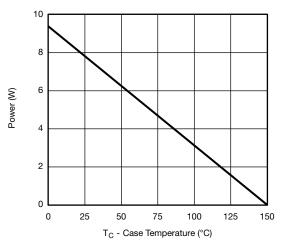


Safe Operating Area, Junction-to-Ambient

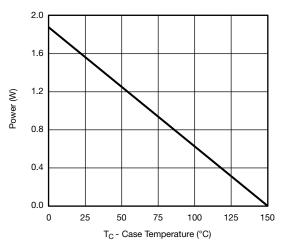


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Power Derating, Junction-to-Case



Power, Junction-to-Ambient

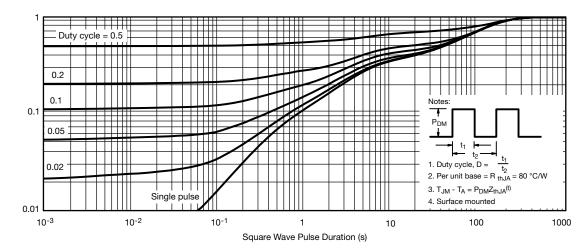
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

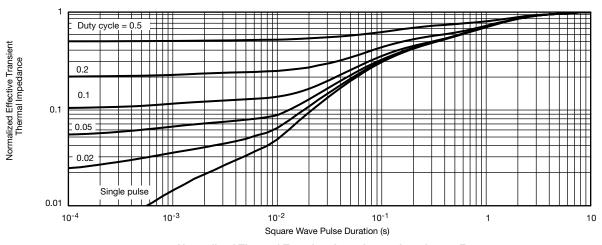


Normalized Effective Transient Thermal Impedance

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69994.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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LON NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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